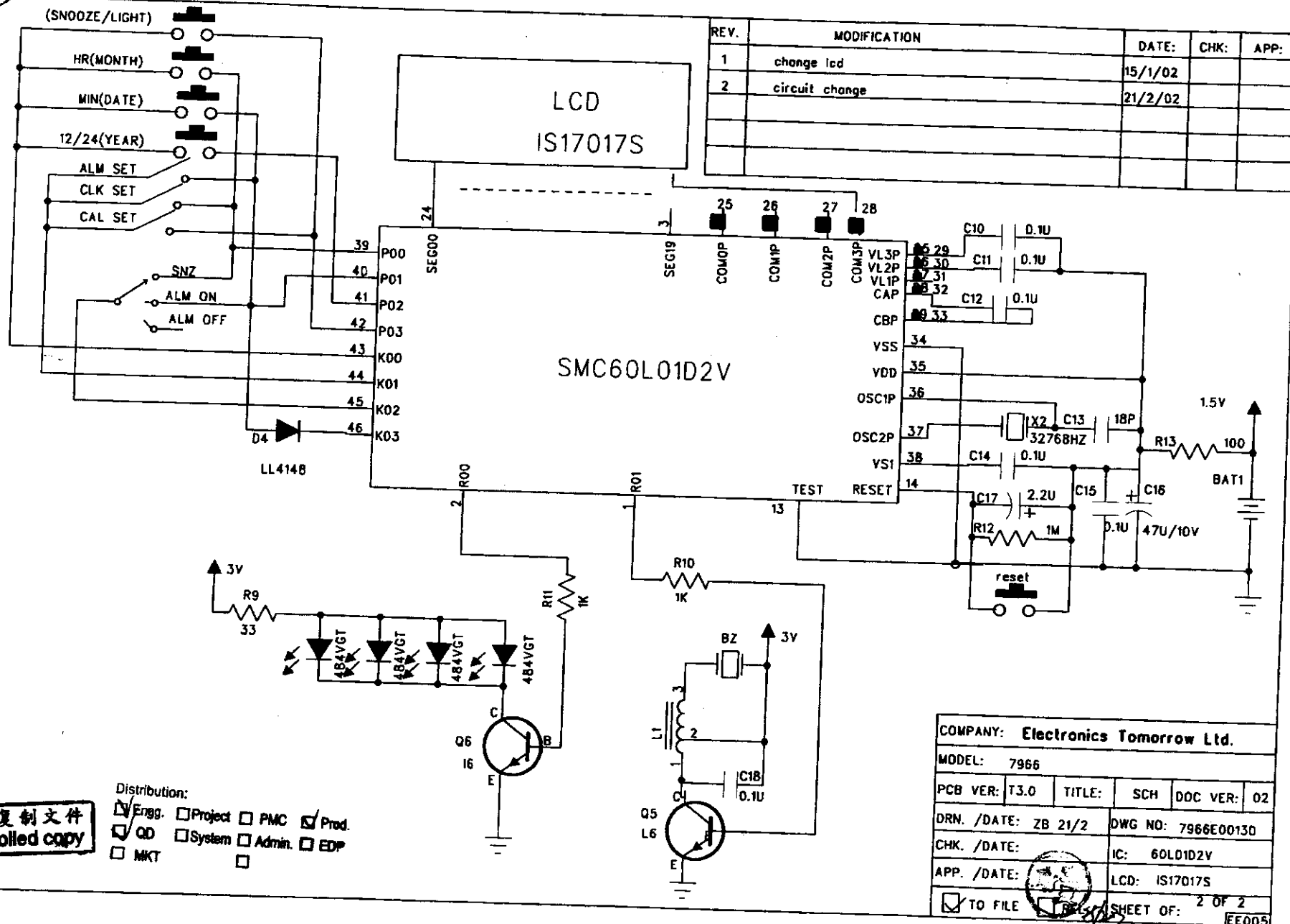


Distribution:

☒ Engg.	☐ Project	☐ P.M.C.	☒ Prod.
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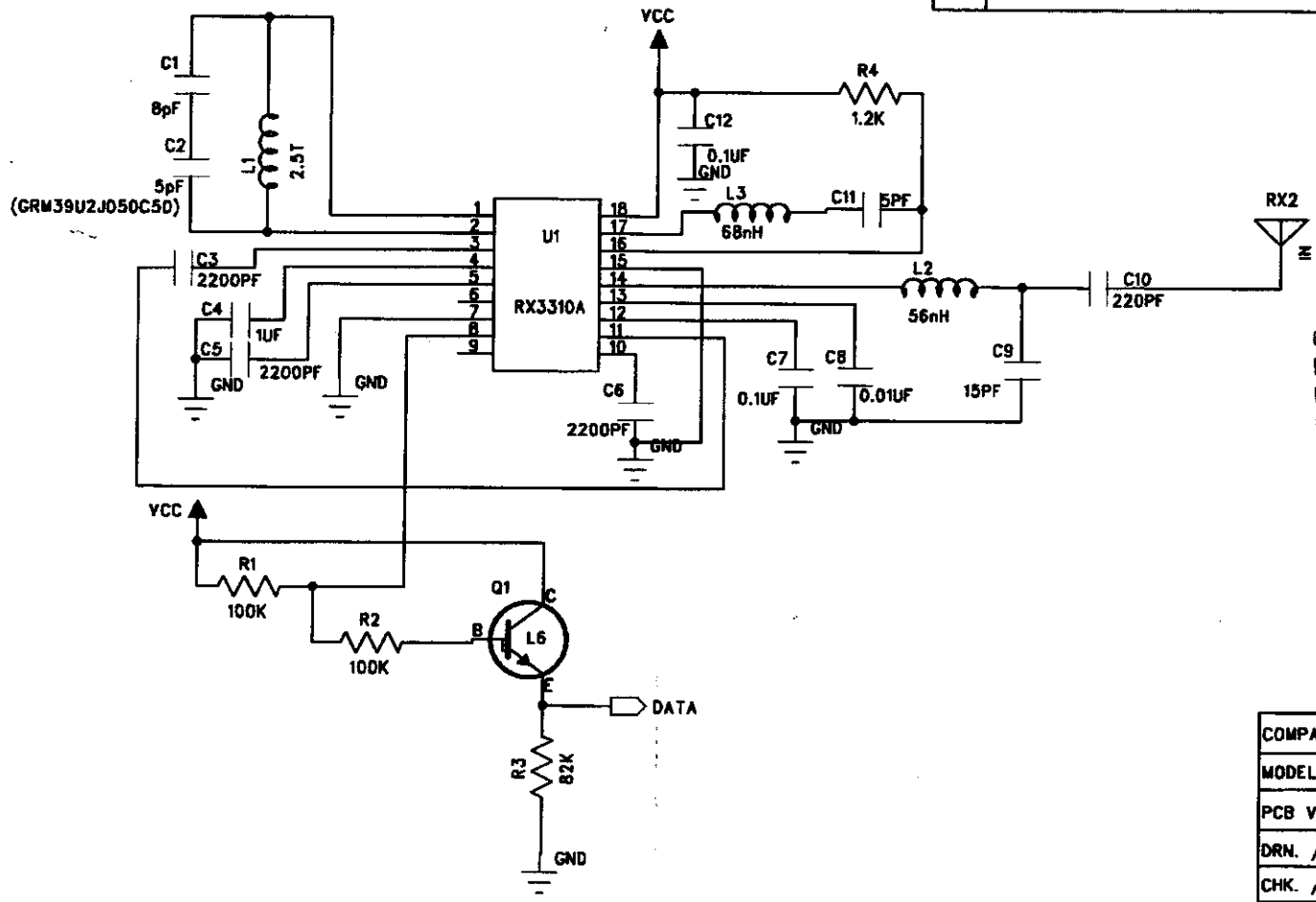
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